

# HD74ALVC162835A

18-bit Universal Bus Driver with 3-state Outputs

**HITACHI**

ADE-205-294C (Z)

Rev. 3  
Oct. 2001

## Description

The HD74ALVC162835A is an 18-bit universal bus driver designed for 2.3 V to 3.6 V  $V_{cc}$  operation.

Data flow from A to Y is controlled by the output enable ( $\overline{OE}$ ). The device operates in the transparent mode when the latch enable (LE) is high. When LE is low, the A data is latched if the clock (CLK) input is held at a high or low logic level. If the LE is low, the A data is stored in the latch/flip flop on the low to high transition of CLK. When  $OE$  is high, the outputs are in the high impedance state.

To ensure the high impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{cc}$  through a pullup resistor; the minimum value of the resistor is determined by the current sinking capability of the driver.

All outputs, which are designed to sink up to 12 mA, include series dumping resistors to reduce overshoot and undershoot.

## Features

- Supports PC133 and meets “PC SDRAM registered DIMM specification, Rev. 1.1”
- $V_{CC} = 2.3\text{ V to }3.6\text{ V}$
- Typical VOL ground bounce < 0.8 V (@ $V_{CC} = 3.3\text{ V}$ ,  $T_a = 25^\circ\text{C}$ )
- Typical VOH undershoot > 2.0 V (@ $V_{CC} = 3.3\text{ V}$ ,  $T_a = 25^\circ\text{C}$ )
- High output current  $\pm 12\text{ mA}$  (@ $V_{CC} = 3.0\text{ V}$ )
- All outputs have series dumping resistors, so no external resistors are required
- $t_{pd}(\text{CLK to Y}) = 3.5\text{ ns (Max)}$  (@ $V_{CC} = 3.3 \pm 0.3\text{ V}$ ,  $CL = 50\text{ pF}$ ,  $T_a = 0\text{ to }85^\circ\text{C}$ )
- $t_{pd}(\text{CLK to Y}) = 2.5\text{ ns (Max)}$  (@ $V_{CC} = 3.3 \pm 0.3\text{ V}$ ,  $CL = 30\text{ pF}$ ,  $T_a = 0\text{ to }85^\circ\text{C}$ )
- Package type

Package type	Package code	Package suffix	Taping code
TSSOP-56pin	TTP-56DAV	T	EL(1000pcs / Reel)
TVSOP-56pin	TTP-56DBV	N	EL(1000pcs / Reel)

**Function Table****Inputs**

<b>OE</b>	<b>LE</b>	<b>CLK</b>	<b>A</b>	<b>Output Y</b>
H	X	X	X	Z
L	H	X	L	L
L	H	X	H	H
L	L	↑	L	L
L	L	↑	H	H
L	L	L or H	X	$Y_0^{-1}$

H : High level

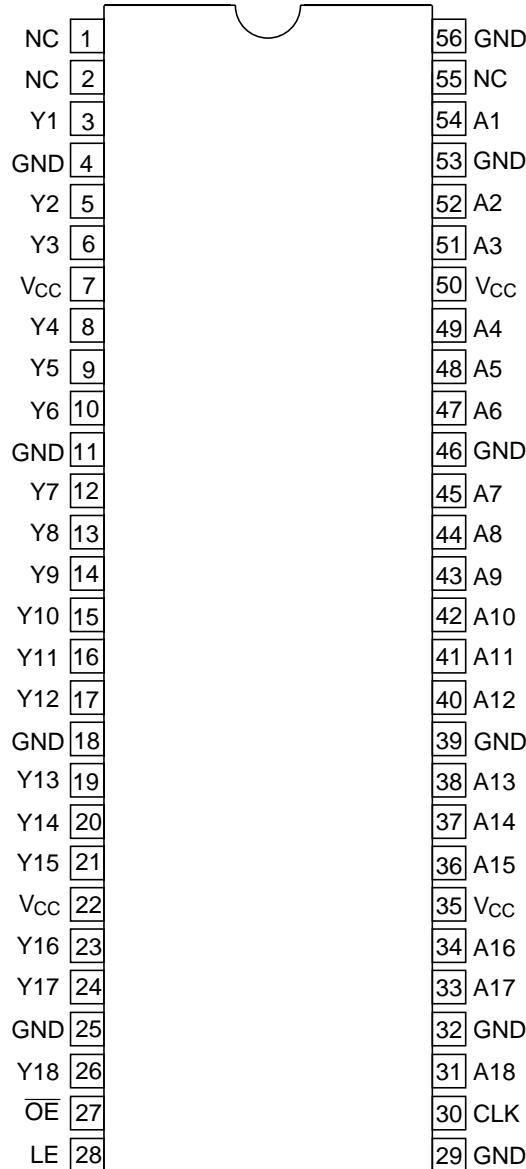
L : Low level

X : Immaterial

Z : High impedance

↑ : Low to high transition

Note: 1. Output level before the indicated steady-state input conditions were established.

**Pin Arrangement**

(Top view)

## Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	Conditions
Supply voltage range	$V_{cc}$	-0.5 to 4.6	V	
Input voltage range <sup>1</sup>	$V_i$	-0.5 to 4.6	V	
Output voltage range <sup>1, 2</sup>	$V_o$	-0.5 to $V_{cc} + 0.5$	V	
Input clamp current	$I_{ik}$	-50	mA	$V_i < 0$
Output clamp current	$I_{ok}$	$\pm 50$	mA	$V_o < 0$ or $V_o > V_{cc}$
Continuous output current	$I_o$	$\pm 50$	mA	$V_o = 0$ to $V_{cc}$
$V_{cc}$ , GND current / pin	$I_{cc}$ or $I_{gnd}$	$\pm 100$	mA	
Maximum power dissipation at $T_a = 55^\circ\text{C}$ (in still air) <sup>3</sup>	$P_T$	1	W	TSSOP TVSOP
Storage temperature range	Tstg	-65 to 150	°C	

Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating condition" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

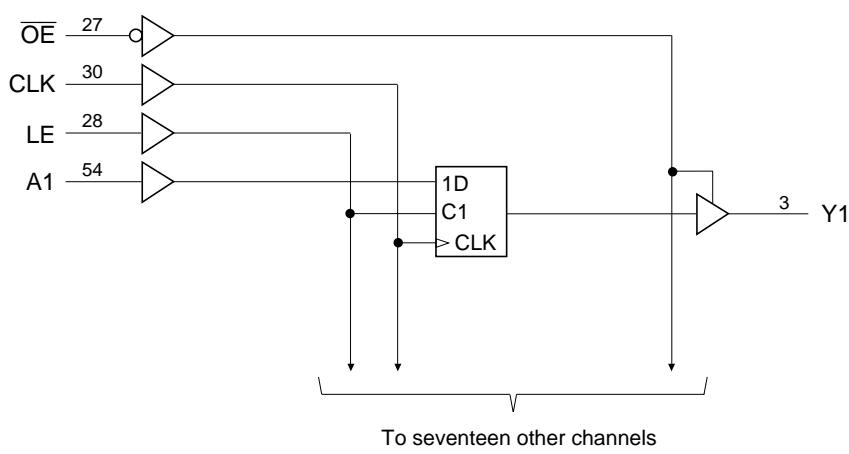
- Notes:
1. The input and output negative-voltage ratings may be exceeded if the input and output clamp current ratings are observed.
  2. The input and output positive-voltage ratings may be exceeded up to 4.6 V if the input and output clamp-current ratings are observed.
  3. The maximum power dissipation is calculated using a junction temperature of 150°C and board trace length of 750 mils.

## Recommended Operating Conditions

Item	Symbol	Min	Max	Unit	Conditions
Supply voltage	$V_{cc}$	2.3	3.6	V	
Input voltage	$V_i$	0	$V_{cc}$	V	
Output voltage	$V_o$	0	$V_{cc}$	V	
High-level output current	$I_{oh}$	—	-6	mA	$V_{cc} = 2.3$ V
		—	-8		$V_{cc} = 2.7$ V
		—	-12		$V_{cc} = 3.0$ V
Low-level output current	$I_{ol}$	—	6	mA	$V_{cc} = 2.3$ V
		—	8		$V_{cc} = 2.7$ V
		—	12		$V_{cc} = 3.0$ V
Input transition rise or fall rate	$dV/dt$	0	10	ns/V	
Operating free-air temperature	$T_a$	-40	85	°C	

Note: Unused or floating control pins must be held high or low.

## Logic Diagram



## Electrical Characteristics

T<sub>a</sub> = -40 to 85°C

Item	Symbol	V <sub>cc</sub> (V)	Min	Max	Unit	Test Conditions
Input voltage	V <sub>IH</sub>	2.3 to 2.7	1.7	—	V	
		2.7 to 3.6	2.0	—		
	V <sub>IL</sub>	2.3 to 2.7	—	0.7	V	
		2.7 to 3.6	—	0.8		
Output voltage	V <sub>OH</sub>	2.3 to 3.6	V <sub>cc</sub> -0.2	—	V	I <sub>OH</sub> = -100 µA
		2.3	1.9	—		I <sub>OH</sub> = -4 mA, V <sub>IH</sub> = 1.7 V
		2.3	1.7	—		I <sub>OH</sub> = -6 mA, V <sub>IH</sub> = 1.7 V
		3.0	2.4	—		I <sub>OH</sub> = -6 mA, V <sub>IH</sub> = 2.0 V
		2.7	2.0	—		I <sub>OH</sub> = -8 mA, V <sub>IH</sub> = 2.0 V
		3.0	2.0	—		I <sub>OH</sub> = -12 mA, V <sub>IH</sub> = 2.0 V
	V <sub>OL</sub>	2.3 to 3.6	—	0.2	V	I <sub>OL</sub> = 100 µA
		2.3	—	0.4		I <sub>OL</sub> = 4 mA, V <sub>IL</sub> = 0.7 V
		2.3	—	0.55		I <sub>OL</sub> = 6 mA, V <sub>IL</sub> = 0.7 V
		3.0	—	0.55		I <sub>OL</sub> = 6 mA, V <sub>IL</sub> = 0.8 V
		2.7	—	0.6		I <sub>OL</sub> = 8 mA, V <sub>IL</sub> = 0.8 V
		3.0	—	0.8		I <sub>OL</sub> = 12 mA, V <sub>IL</sub> = 0.8 V
Input current	I <sub>IN</sub>	3.6	—	±5.0	µA	V <sub>IN</sub> = V <sub>cc</sub> or GND
Off state output current	I <sub>OZ</sub>	3.6	—	±10	µA	V <sub>OUT</sub> = V <sub>cc</sub> or GND
Quiescent supply current	I <sub>cc</sub>	3.6	—	40	µA	V <sub>IN</sub> = V <sub>cc</sub> or GND
	ΔI <sub>cc</sub>	3.0 to 3.6	—	750	µA	One input at (V <sub>cc</sub> -0.6)V, other inputs at V <sub>cc</sub> or GND

## Switching Characteristics

(Ta = -40 to 85°C)

Item	Symbol	V <sub>cc</sub> (V)	Min	Typ	Max	Unit	From (Input)	To (Output)
Maximum clock frequency	f <sub>max</sub>	2.5±0.2	150	—	—	MHz		
		2.7	150	—	—			
		3.3±0.3	150	—	—			
Propagation delay time	t <sub>PLH</sub>	2.5±0.2	1.0	—	5.0	ns	A	Y
		2.7	—	—	5.0			
		3.3±0.3	1.0	—	4.2			
	t <sub>PHL</sub>	2.5±0.2	1.3	—	5.9		LE	Y
		2.7	—	—	5.8			
		3.3±0.3	1.3	—	5.1			
		2.5±0.2	1.4	—	6.3		CLK	Y
		2.7	—	—	6.1			
		3.3±0.3	1.4	—	5.4			
Output enable time	t <sub>ZH</sub>	2.5±0.2	1.4	—	6.3	ns	OE	Y
	t <sub>ZL</sub>	2.7	—	—	6.5			
		3.3±0.3	1.1	—	5.5			
Output disable time	t <sub>HZ</sub>	2.5±0.2	1.0	—	4.7	ns	OE	Y
	t <sub>LZ</sub>	2.7	—	—	4.9			
		3.3±0.3	1.3	—	4.5			
Input capacitance	C <sub>IN</sub>	3.3	3.3	4.0	4.5	pF	Control inputs	
		3.3	3.0	6.0	9.0		Data inputs	
Output capacitance	C <sub>O</sub>	3.3	3.0	7.0	9.0	pF	Y ports	

## Switching Characteristics

(Ta = -40 to 85°C) (cont)

Item	Symbol	V <sub>cc</sub> (V)	Min	Typ	Max	Unit	From (Input)
Setup time	t <sub>su</sub>	2.5±0.2	2.2	—	—	ns	Data before CLK↑
		2.7	2.1	—	—		
		3.3±0.3	1.7	—	—		
		2.5±0.2	1.9	—	—		Data before LE↓
		2.7	1.6	—	—		CLK "H"
		3.3±0.3	1.5	—	—		
		2.5±0.2	1.3	—	—		Data before LE↓
		2.7	1.1	—	—		CLK "L"
		3.3±0.3	1.0	—	—		
Hold time	t <sub>h</sub>	2.5±0.2	0.6	—	—	ns	Data after CLK↑
		2.7	0.6	—	—		
		3.3±0.3	0.7	—	—		
		2.5±0.2	1.4	—	—		Data after LE↓
		2.7	1.7	—	—		CLK "H" or "L"
		3.3±0.3	1.4	—	—		
Pulse width	t <sub>w</sub>	2.5±0.2	3.3	—	—	ns	LE "H"
		2.7	3.3	—	—		
		3.3±0.3	3.3	—	—		
		2.5±0.2	3.3	—	—		CLK "H" or "L"
		2.7	3.3	—	—		
		3.3±0.3	3.3	—	—		

## Switching Characteristics

(Ta = 0 to 85°C)

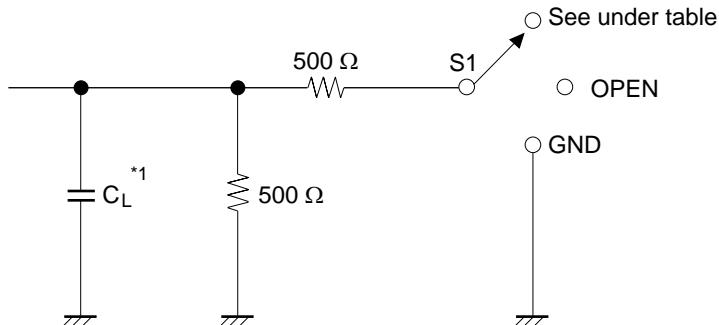
Item	Symbol	V <sub>cc</sub> (V)	Min	Typ	Max	Unit	FROM (Input)	TO (Output)
Propagation delay time	C <sub>L</sub> =50pF	t <sub>PLH</sub> , t <sub>PHL</sub>	3.3±0.3	1.4	—	3.5	ns	CLK Y
	C <sub>L</sub> =30pF		3.3±0.3	0.7	—	2.5		CLK Y
Setup time	t <sub>su</sub>		3.3±0.3	1.0	—	—	ns	Data before CLK↑
Hold time	t <sub>h</sub>		3.3±0.3	0.6	—	—	ns	Data after CLK↑

## Operating Characteristics

(Ta = 25°C)

Item	Symbol	V <sub>cc</sub> = 2.5±0.2 V	V <sub>cc</sub> = 3.3±0.3 V	Unit	Test Conditions
		Typ	Typ		
Power dissipation capacitance	Outputs enable	C <sub>pd</sub>	22.0	24.5	pF C <sub>L</sub> = 0, f = 10 MHz
	Outputs disable		5.0	6.0	

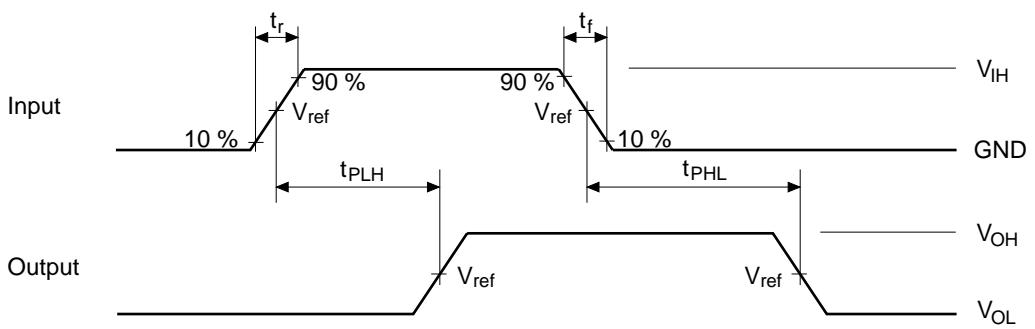
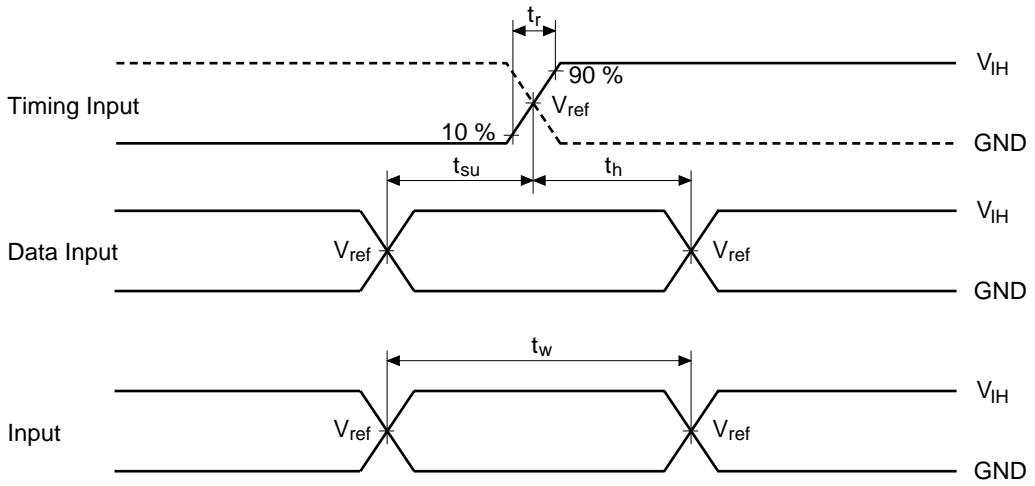
## Test Circuit



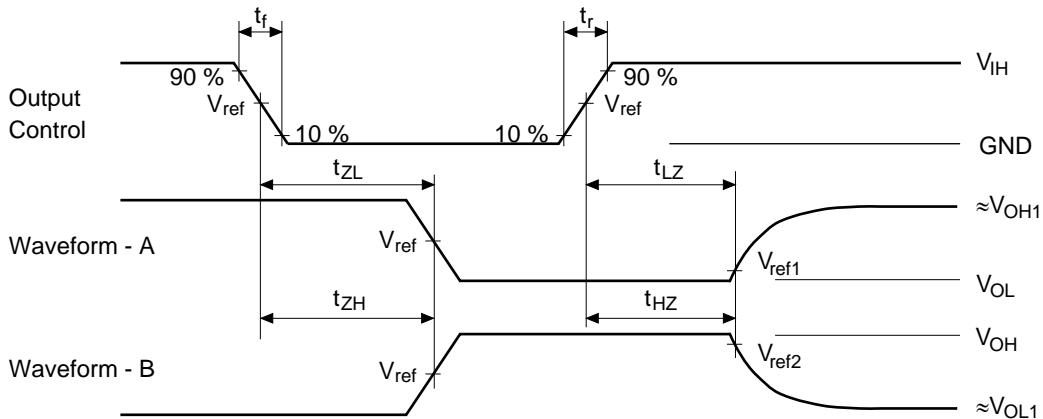
Load Circuit for Outputs

Symbol	$V_{CC}=2.5\pm0.2V$	$V_{CC}=2.7V, 3.3\pm0.3V$
$t_{PLH} / t_{PHL}$	OPEN	OPEN
$t_{su} / t_h / t_w$		
$t_{ZH} / t_{HZ}$	GND	GND
$t_{ZL} / t_{LZ}$	$2 \times V_{CC}$	6.0 V
$C_L$	30 pF	50 pF

Note: 1.  $C_L$  includes probe and jig capacitance.

**Waveforms – 1****Waveforms – 2**

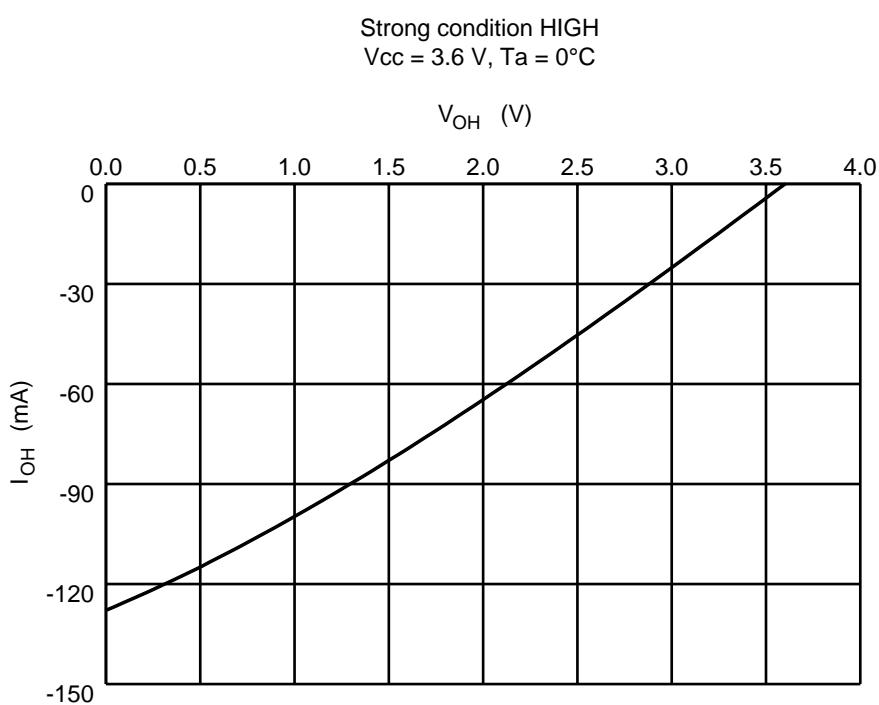
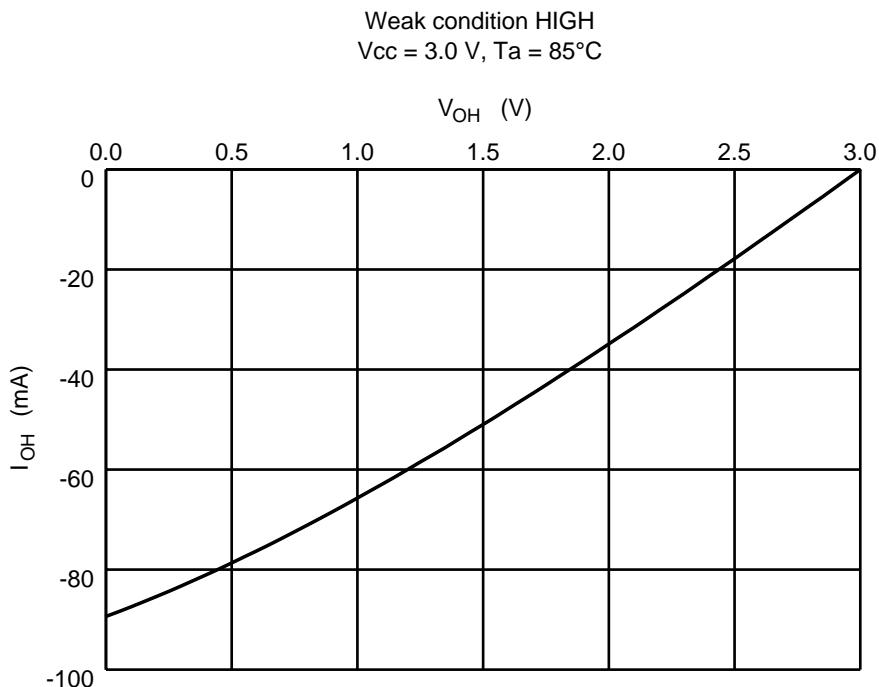
## Waveforms – 3



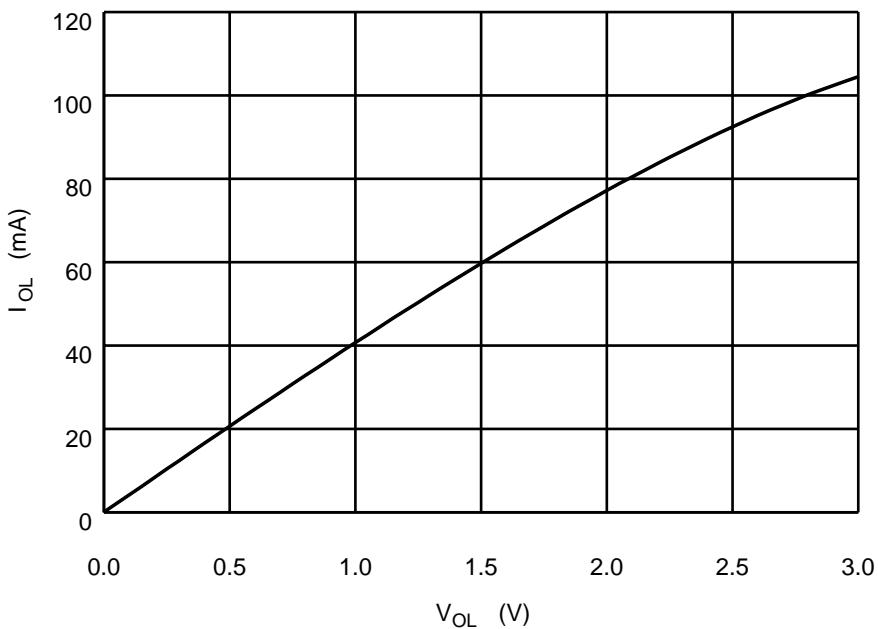
TEST	$V_{CC}=2.5\pm 0.2V$	$V_{CC}=2.7V, 3.3\pm 0.3V$
$V_{IH}$	$V_{CC}$	2.7 V
$V_{ref}$	$1/2 V_{CC}$	1.5 V
$V_{ref1}$	$V_{OL} + 0.15 V$	$V_{OL} + 0.3 V$
$V_{ref2}$	$V_{OH} - 0.15 V$	$V_{OH} - 0.3 V$
$V_{OH1}$	$V_{CC}$	3.0 V
$V_{OL1}$	GND	GND

- Notes:
- All input pulses are supplied by generators having the following characteristics :  
PRR • 10 MHz,  $Z_o = 50 \Omega$ ,  $t_r = 2.0$  ns,  $t_f = 2.0$  ns. ( $V_{cc} = 2.5 \pm 0.2$  V)  
PRR • 10 MHz,  $Z_o = 50 \Omega$ ,  $t_r = 2.5$  ns,  $t_f = 2.5$  ns. ( $V_{cc} = 2.7$  V,  $3.3 \pm 0.3$  V)
  - Waveform – A is for an output with internal conditions such that the output is low except when disabled by the output control.
  - Waveform – B is for an output with internal conditions such that the output is high except when disabled by the output control.
  - The output are measured one at a time with one transition per measurement.

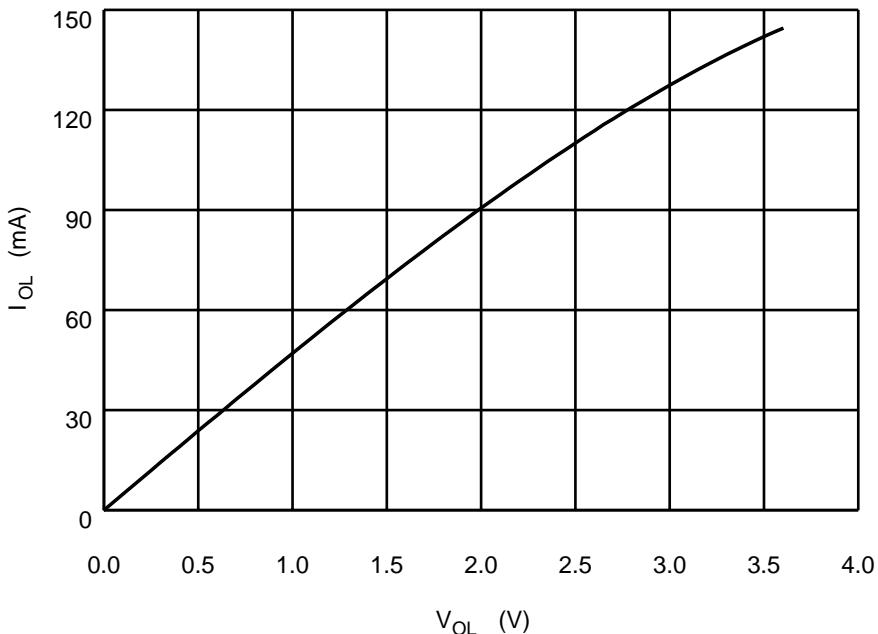
## IV Characteristics for Register Output (Measured value)



Weak condition LOW  
V<sub>cc</sub> = 3.0 V, Ta = 85°C



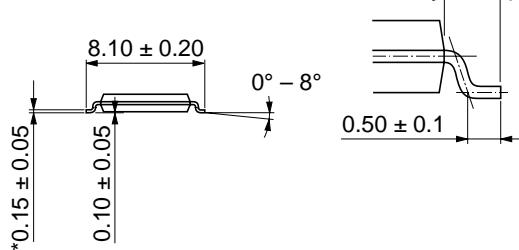
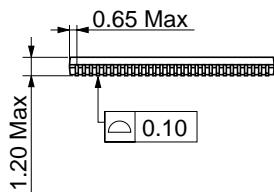
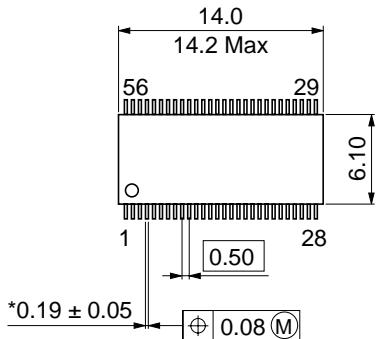
Strong condition LOW  
V<sub>cc</sub> = 3.6 V, Ta = 0°C



## Package Dimensions

As of July, 2001

Unit: mm

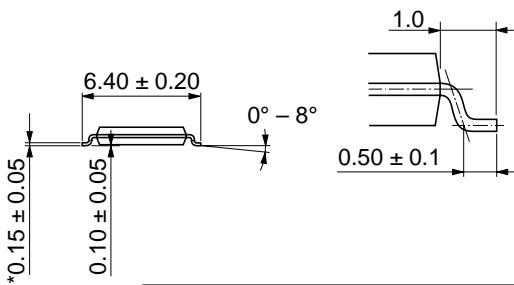
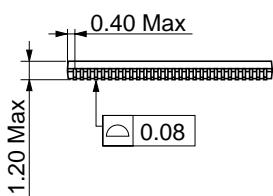
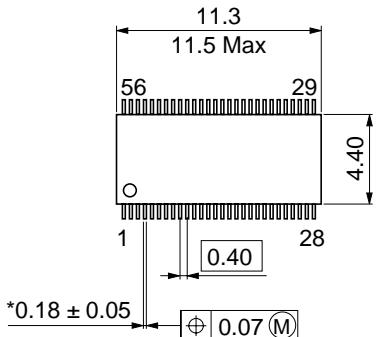


Hitachi Code	TTP-56DAV
JEDEC	—
JEITA	—
Mass (reference value)	0.32 g

\*Pd plating

# HD74ALVC162835A

As of July, 2001  
Unit: mm



Hitachi Code	TTP-56DBV
JEDEC	—
JEITA	—
Mass (reference value)	—

\*Pd plating

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